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"[Embedded - Microcontrollers](#)" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "[Embedded - Microcontrollers](#)"

Details

Product Status	Active
Core Processor	M16C/60
Core Size	16-Bit
Speed	24MHz
Connectivity	CANbus, I ² C, IEBus, SIO, UART/USART
Peripherals	DMA, WDT
Number of I/O	111
Program Memory Size	512KB (512K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	31K x 8
Voltage - Supply (Vcc/Vdd)	3V ~ 5.5V
Data Converters	A/D 26x10b; D/A 2x8b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	128-LQFP
Supplier Device Package	128-LFQFP (14x20)
Purchase URL	https://www.e-xfl.com/product-detail/renesas-electronics-america/m306nmfjgp-u3

M16C/6N Group (M16C/6NK, M16C/6NM)

Renesas MCU

REJ03B0058-0210

Rev.2.10

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1. Overview

The M16C/6N Group (M16C/6NK, M16C/6NM) of MCUs are built using the high-performance silicon gate CMOS process using the M16C/60 Series CPU core and are packaged in 100-pin and 128-pin plastic molded LQFP. These MCUs operate using sophisticated instructions featuring a high level of instruction efficiency. With 1 Mbyte of address space, they are capable of executing instructions at high speed. Being equipped with two CAN (Controller Area Network) modules in the M16C/6N Group (M16C/6NK, M16C/6NM), the MCU is suited to drive automotive and industrial control systems. The CAN modules comply with the 2.0B specification. In addition, this MCU contains a multiplier and DMAC which combined with fast instruction processing capability, makes it suitable for control of various OA, communication equipment which requires high-speed arithmetic/logic operations.

1.1 Applications

- Car audio and industrial control systems, other (Normal-ver. product)
- Automotive, industrial control systems and other automobile, other (T/V-ver. product)

Specifications written in this manual are believed to be accurate, but are not guaranteed to be entirely free of error. Specifications in this manual may be changed for functional or performance improvements. Please make sure your manual is the latest edition.

Table 1.4 List of Pin Names for 100-Pin Package (1)

Pin No.	Control Pin	Port	Interrupt Pin	Timer Pin	UART Pin	Analog Pin	CAN Module Pin	Bus Control Pin ⁽¹⁾
1		P9_4		TB4IN		DA1		
2		P9_3		TB3IN		DA0		
3		P9_2		TB2IN	SOUT3			
4		P9_1		TB1IN	SIN3			
5		P9_0		TB0IN	CLK3			
6	BYTE							
7	CNVSS							
8	XCIN	P8_7						
9	XCOUT	P8_6						
10	RESET							
11	XOUT							
12	VSS							
13	XIN							
14	VCC1							
15		P8_5	NMI					
16		P8_4	INT2	ZP				
17		P8_3	INT1					
18		P8_2	INT0					
19		P8_1		TA4IN/U				
20		P8_0		TA4OUT/U	(SIN4)			
21		P7_7		TA3IN			CRX1	
22		P7_6		TA3OUT			CTX1	
23		P7_5		TA2IN/W	(SOUT4)			
24		P7_4		TA2OUT/W	(CLK4)			
25		P7_3		TA1IN/V	CTS2/RTS2			
26		P7_2		TA1OUT/V	CLK2			
27		P7_1		TA0IN/TB5IN	RXD2/SCL2			
28		P7_0		TA0OUT	TXD2/SDA2			
29		P6_7			TXD1/SDA1			
30		P6_6			RXD1/SCL1			
31		P6_5			CLK1			
32		P6_4			CTS1/RTS1/CTS0/CLKS1			
33		P6_3			TXD0/SDA0			
34		P6_2			RXD0/SCL0			
35		P6_1			CLK0			
36		P6_0			CTS0/RTS0			
37		P5_7						RDY/CLKOUT
38		P5_6						ALE
39		P5_5						HOLD
40		P5_4						HLDA
41		P5_3						BCLK
42		P5_2						RD
43		P5_1						WRH/BHE
44		P5_0						WRL/WR
45		P4_7						CS3
46		P4_6						CS2
47		P4_5						CS1
48		P4_4						CS0
49		P4_3						A19
50		P4_2						A18

NOTE:

1. Not available the bus control pins (except CLKOUT pin; Pin No.37) in T/V-ver..

Table 1.8 List of Pin Names for 128-Pin Package (3)

Pin No.	Control Pin	Port	Interrupt Pin	Timer Pin	UART Pin	Analog Pin	CAN Module Pin	Bus Control Pin ⁽¹⁾
101		P1_2						D10
102		P1_1						D9
103		P1_0						D8
104		P0_7				AN0_7		D7
105		P0_6				AN0_6		D6
106		P0_5				AN0_5		D5
107		P0_4				AN0_4		D4
108		P0_3				AN0_3		D3
109		P0_2				AN0_2		D2
110		P0_1				AN0_1		D1
111		P0_0				AN0_0		D0
112		P11_7			SIN6			
113		P11_6			SOUT6			
114		P11_5			CLK6			
115		P11_4						
116		P11_3						
117		P11_2			SOUT5			
118		P11_1			SIN5			
119		P11_0			CLK5			
120		P10_7	KI3			AN7		
121		P10_6	KI2			AN6		
122		P10_5	KI1			AN5		
123		P10_4	KI0			AN4		
124		P10_3				AN3		
125		P10_2				AN2		
126		P10_1				AN1		
127	AVSS							
128		P10_0				AN0		

NOTE:

1. Not available the bus control pins in T/V-ver..

1.6 Pin Functions

Tables 1.9 to 1.11 list the Pin Functions.

Table 1.9 Pin Functions (100-pin and 128-pin Versions) (1)

Signal Name	Pin Name	I/O Type	Description
Power supply input	VCC1, VCC2, VSS	I	Apply 3.0 to 5.5 V to the VCC1 and VCC2 pins and 0 V to the VSS pin. The VCC apply condition is that VCC2 = VCC1 ⁽¹⁾ .
Analog power supply input	AVCC, AVSS	I	Applies the power supply for the A/D converter. Connect the AVCC pin to VCC1. Connect the AVSS pin to VSS.
Reset input	RESET	I	The MCU is in a reset state when applying “L” to the this pin.
CNVSS ⁽²⁾	CNVSS	I	Switches processor mode. Connect this pin to VSS to when after a reset to start up in single-chip mode. Connect this pin to VCC1 to start up in microprocessor mode.
External data bus width select input ⁽²⁾	BYTE	I	Switches the data bus in external memory space. The data bus is 16-bit long when the this pin is held “L” and 8-bit long when the this pin is held “H”. Set it to either one. Connect this pin to VSS when single-chip mode.
Bus control pins ⁽³⁾	D0 to D7	I/O	Inputs and outputs data (D0 to D7) when these pins are set as the separate bus.
	D8 to D15	I/O	Inputs and outputs data (D8 to D15) when external 16-bit data bus is set as the separate bus.
	A0 to A19	O	Output address bits (A0 to A19).
	A0/D0 to A7/D7	I/O	Input and output data (D0 to D7) and output address bits (A0 to A7) by time-sharing when external 8-bit data bus are set as the multiplexed bus.
	A1/D0 to A8/D7	I/O	Input and output data (D0 to D7) and output address bits (A1 to A8) by time-sharing when external 16-bit data bus are set as the multiplexed bus.
	CS0 to CS3	O	Output CS0 to CS3 signals. CS0 to CS3 are chip-select signals to specify an external space.
	WRL/WR WRH/BHE RD	O	Output WRL, WRH, (WR, BHE), RD signals. WRL and WRH or BHE, and WR can be switched by program. <ul style="list-style-type: none"> • WRL, WRH, and RD are selected The WRL signal becomes “L” by writing data to an even address in an external memory space. The WRH signal becomes “L” by writing data to an odd address in an external memory space. The RD pin signal becomes “L” by reading data in an external memory space. • WR, BHE, and RD are selected The WR signal becomes “L” by writing data in an external memory space. The RD signal becomes “L” by reading data in an external memory space. The BHE signal becomes “L” by accessing an odd address. Select WR, BHE, and RD for an external 8-bit data bus.
	ALE	O	ALE is a signal to latch the address.
	HOLD	I	While the HOLD pin is held “L”, the MCU is placed in a hold state.
	HLDA	O	In a hold state, HLDA outputs a “L” signal.
	RDY	I	While applying a “L” signal to the RDY pin, the MCU is placed in a wait state.

I: Input O: Output I/O: Input/Output

NOTES:

1. In this manual, hereafter, VCC refers to VCC1 unless otherwise noted.
2. Connect to VSS in T/V-ver..
3. Not available the bus control pins in T/V-ver..

3. Memory

Figure 3.1 shows a Memory Map. The address space extends the 1 Mbyte from address 00000h to FFFFFh. The internal ROM is allocated in a lower address direction beginning with address FFFFFh. For example, a 512-Kbyte internal ROM is allocated to the addresses from 80000h to FFFFFh.

As for the flash memory version, 4-Kbyte space (block A) exists in 0F000h to 0FFFFh. 4-Kbyte space is mainly for storing data. In addition to storing data, 4-Kbyte space also can store programs.

The fixed interrupt vector table is allocated to the addresses from FFFDCh to FFFFFh. Therefore, store the start address of each interrupt routine here.

The internal RAM is allocated in an upper address direction beginning with address 00400h. For example, a 31-Kbyte internal RAM is allocated to the addresses from 00400h to 07FFFh. In addition to storing data, the internal RAM also stores the stack used when calling subroutines and when interrupts are generated.

The Special Function Registers (SFRs) are allocated to the addresses from 00000h to 003FFh. Peripheral function control registers are located here. Of the SFR, any area which has no functions allocated is reserved for future use and cannot be accessed by user.

The special page vector table is allocated to the addresses from FFE00h to FFFDBh. This vector is used by the JMPS or JSRS instruction. For details, refer to **M16C/60, M16C/20, M16C/Tiny Series Software Manual**. In memory expansion and microprocessor modes, some areas are reserved for future use and cannot be used by users.

Use T/V-ver. in single-chip mode. The memory expansion and microprocessor modes cannot be used.

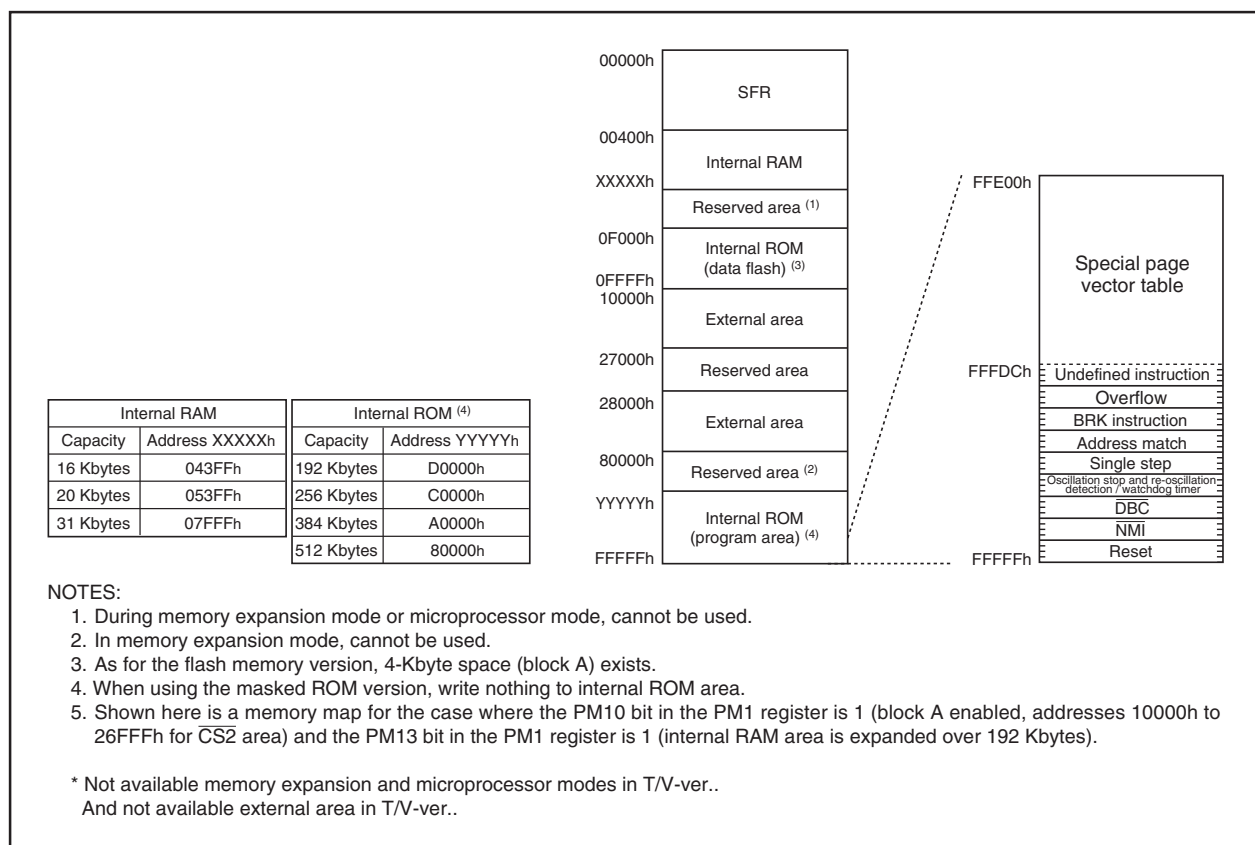


Figure 3.1 Memory Map

Table 4.6 SFR Information (6) ⁽¹⁾

Address	Register	Symbol	After Reset
0140h	CAN0 Message Box 14: Identifier /DLC		XXh
0141h			XXh
0142h			XXh
0143h			XXh
0144h			XXh
0145h			XXh
0146h	CAN0 Message Box 14: Data Field		XXh
0147h			XXh
0148h			XXh
0149h			XXh
014Ah			XXh
014Bh			XXh
014Ch			XXh
014Dh			XXh
014Eh	CAN0 Message Box 14: Time Stamp		XXh
014Fh			XXh
0150h	CAN0 Message Box 15: Identifier /DLC		XXh
0151h			XXh
0152h			XXh
0153h			XXh
0154h			XXh
0155h			XXh
0156h	CAN0 Message Box 15: Data Field		XXh
0157h			XXh
0158h			XXh
0159h			XXh
015Ah			XXh
015Bh			XXh
015Ch			XXh
015Dh			XXh
015Eh	CAN0 Message Box 15: Time Stamp		XXh
015Fh			XXh
0160h	CAN0 Global Mask Register	C0GMR	XXh
0161h			XXh
0162h			XXh
0163h			XXh
0164h			XXh
0165h			XXh
0166h	CAN0 Local Mask A Register	C0LMAR	XXh
0167h			XXh
0168h			XXh
0169h			XXh
016Ah			XXh
016Bh			XXh
016Ch	CAN0 Local Mask B Register	C0LMBR	XXh
016Dh			XXh
016Eh			XXh
016Fh			XXh
0170h			XXh
0171h			XXh
0172h			
0173h			
0174h			
0175h			
0176h			
0177h			
0178h			
0179h			
017Ah			
017Bh			
017Ch			
017Dh			
017Eh			
017Fh			

X: Undefined

NOTE:

- Blank spaces are reserved. No access is allowed.

Table 4.8 SFR Information (8) ⁽³⁾

Address	Register	Symbol	After Reset
01C0h	Timer B3, B4, B5 Count Start Flag	TBSR	000XXXXXb
01C1h	Timer A1-1 Register	TA11	XXh
01C2h			XXh
01C3h			XXh
01C4h	Timer A2-1 Register	TA21	XXh
01C5h			XXh
01C6h			XXh
01C7h	Timer A4-1 Register	TA41	XXh
01C8h			XXh
01C9h			XXh
01CAh	Three-Phase PWM Control Register 0	INVC0	00h
01CBh	Three-Phase PWM Control Register 1	INVC1	00h
01CAh	Three-Phase Output Buffer Register 0	IDB0	00111111b
01CBh	Three-Phase Output Buffer Register 1	IDB1	00111111b
01CCh	Dead Time Timer	DTT	XXh
01CDh	Timer B2 Interrupt Generation Frequency Set Counter	ICTB2	XXh
01CEh			
01CFh	Interrupt Source Select Register 2	IFSR2	X0000000b
01D0h	Timer B3 Register	TB3	XXh
01D1h			XXh
01D2h			XXh
01D3h	Timer B4 Register	TB4	XXh
01D4h			XXh
01D5h			XXh
01D6h	Timer B5 Register	TB5	XXh
01D7h			XXh
01D8h			XXh
01D9h	SI/O6 Transmit/Receive Register ⁽¹⁾	S6TRR	XXh
01D7h			
01D8h	SI/O6 Control Register ⁽¹⁾	S6C	01000000b
01D9h	SI/O6 Bit Rate Register ⁽¹⁾	S6BRG	XXh
01DAh	SI/O3, 4, 5, 6 Transmit/Receive Register ⁽²⁾	S3456TRR	XXXX0000b
01DBh	Timer B3 Mode Register	TB3MR	00XX0000b
01DCh	Timer B4 Mode Register	TB4MR	00XX0000b
01DDh	Timer B5 Mode Register	TB5MR	00XX0000b
01DEh	Interrupt Source Select Register 0	IFSR0	00h
01DFh	Interrupt Source Select Register 1	IFSR1	00h
01E0h	SI/O3 Transmit/Receive Register	S3TRR	XXh
01E1h			
01E2h	SI/O3 Control Register	S3C	01000000b
01E3h	SI/O3 Bit Rate Register	S3BRG	XXh
01E4h	SI/O4 Transmit/Receive Register	S4TRR	XXh
01E5h			
01E6h	SI/O4 Control Register	S4C	01000000b
01E7h	SI/O4 Bit Rate Register	S4BRG	XXh
01E8h	SI/O5 Transmit/Receive Register ⁽¹⁾	S5TRR	XXh
01E9h			
01EAh	SI/O5 Control Register ⁽¹⁾	S5C	01000000b
01EBh	SI/O5 Bit Rate Register ⁽¹⁾	S5BRG	XXh
01ECh	UART0 Special Mode Register 4	U0SMR4	00h
01EDh	UART0 Special Mode Register 3	U0SMR3	000X0X0Xb
01EEh	UART0 Special Mode Register 2	U0SMR2	X0000000b
01EFh	UART0 Special Mode Register	U0SMR	X0000000b
01F0h	UART1 Special Mode Register 4	U1SMR4	00h
01F1h	UART1 Special Mode Register 3	U1SMR3	000X0X0Xb
01F2h	UART1 Special Mode Register 2	U1SMR2	X0000000b
01F3h	UART1 Special Mode Register	U1SMR	X0000000b
01F4h	UART2 Special Mode Register 4	U2SMR4	00h
01F5h	UART2 Special Mode Register 3	U2SMR3	000X0X0Xb
01F6h	UART2 Special Mode Register 2	U2SMR2	X0000000b
01F7h	UART2 Special Mode Register	U2SMR	X0000000b
01F8h	UART2 Transmit/Receive Mode Register	U2MR	00h
01F9h	UART2 Bit Rate Register	U2BRG	XXh
01FAh	UART2 Transmit Buffer Register	U2TB	XXh
01FBh			XXh
01FCh	UART2 Transmit/Receive Control Register 0	U2C0	00001000b
01FDh	UART2 Transmit/Receive Control Register 1	U2C1	00000010b
01FEh	UART2 Receive Buffer Register	U2RB	XXh
01FFh			XXh

X: Undefined

NOTES:

1. These registers exist only in the 128-pin version.
2. Bits S5TRF and S6TRF in the S3456TRR register are used in the 128-pin version.
3. Blank spaces are reserved. No access is allowed.

Table 4.9 SFR Information (9)

Address	Register	Symbol	After Reset
0200h	CAN0 Message Control Register 0	C0MCTL0	00h
0201h	CAN0 Message Control Register 1	C0MCTL1	00h
0202h	CAN0 Message Control Register 2	C0MCTL2	00h
0203h	CAN0 Message Control Register 3	C0MCTL3	00h
0204h	CAN0 Message Control Register 4	C0MCTL4	00h
0205h	CAN0 Message Control Register 5	C0MCTL5	00h
0206h	CAN0 Message Control Register 6	C0MCTL6	00h
0207h	CAN0 Message Control Register 7	C0MCTL7	00h
0208h	CAN0 Message Control Register 8	C0MCTL8	00h
0209h	CAN0 Message Control Register 9	C0MCTL9	00h
020Ah	CAN0 Message Control Register 10	C0MCTL10	00h
020Bh	CAN0 Message Control Register 11	C0MCTL11	00h
020Ch	CAN0 Message Control Register 12	C0MCTL12	00h
020Dh	CAN0 Message Control Register 13	C0MCTL13	00h
020Eh	CAN0 Message Control Register 14	C0MCTL14	00h
020Fh	CAN0 Message Control Register 15	C0MCTL15	00h
0210h	CAN0 Control Register	C0CTLR	X0000001b
0211h			XX0X0000b
0212h	CAN0 Status Register	C0STR	00h
0213h			X0000001b
0214h	CAN0 Slot Status Register	C0SSTR	00h
0215h			00h
0216h	CAN0 Interrupt Control Register	C0ICR	00h
0217h			00h
0218h	CAN0 Extended ID Register	C0IDR	00h
0219h			00h
021Ah	CAN0 Configuration Register	C0CONR	XXh
021Bh			XXh
021Ch	CAN0 Receive Error Count Register	C0RECR	00h
021Dh	CAN0 Transmit Error Count Register	C0TECR	00h
021Eh	CAN0 Time Stamp Register	C0TSR	00h
021Fh			00h
0220h	CAN1 Message Control Register 0	C1MCTL0	00h
0221h	CAN1 Message Control Register 1	C1MCTL1	00h
0222h	CAN1 Message Control Register 2	C1MCTL2	00h
0223h	CAN1 Message Control Register 3	C1MCTL3	00h
0224h	CAN1 Message Control Register 4	C1MCTL4	00h
0225h	CAN1 Message Control Register 5	C1MCTL5	00h
0226h	CAN1 Message Control Register 6	C1MCTL6	00h
0227h	CAN1 Message Control Register 7	C1MCTL7	00h
0228h	CAN1 Message Control Register 8	C1MCTL8	00h
0229h	CAN1 Message Control Register 9	C1MCTL9	00h
022Ah	CAN1 Message Control Register 10	C1MCTL10	00h
022Bh	CAN1 Message Control Register 11	C1MCTL11	00h
022Ch	CAN1 Message Control Register 12	C1MCTL12	00h
022Dh	CAN1 Message Control Register 13	C1MCTL13	00h
022Eh	CAN1 Message Control Register 14	C1MCTL14	00h
022Fh	CAN1 Message Control Register 15	C1MCTL15	00h
0230h	CAN1 Control Register	C1CTLR	X0000001b
0231h			XX0X0000b
0232h	CAN1 Status Register	C1STR	00h
0233h			X0000001b
0234h	CAN1 Slot Status Register	C1SSTR	00h
0235h			00h
0236h	CAN1 Interrupt Control Register	C1ICR	00h
0237h			00h
0238h	CAN1 Extended ID Register	C1IDR	00h
0239h			00h
023Ah	CAN1 Configuration Register	C1CONR	XXh
023Bh			XXh
023Ch	CAN1 Receive Error Count Register	C1RECR	00h
023Dh	CAN1 Transmit Error Count Register	C1TECR	00h
023Eh	CAN1 Time Stamp Register	C1TSR	00h
023Fh			00h

X: Undefined

Table 4.10 SFR Information (10) ⁽¹⁾

Address	Register	Symbol	After Reset
0240h			
0241h			
0242h	CAN0 Acceptance Filter Support Register	C0AFS	XXh
0243h			XXh
0244h	CAN1 Acceptance Filter Support Register	C1AFS	XXh
0245h			XXh
0246h			
0247h			
0248h			
0249h			
024Ah			
024Bh			
024Ch			
024Dh			
024Eh			
024Fh			
0250h			
0251h			
0252h			
0253h			
0254h			
0255h			
0256h			
0257h			
0258h			
0259h			
025Ah			
025Bh			
025Ch			
025Dh			
025Eh	Peripheral Clock Select Register	PCLKR	00h
025Fh	CAN0/1 Clock Select Register	CCLKR	00h
0260h	CAN1 Message Box 0: Identifier / DLC		XXh
0261h			XXh
0262h			XXh
0263h			XXh
0264h			XXh
0265h	CAN1 Message Box 0: Data Field		XXh
0266h			XXh
0267h			XXh
0268h			XXh
0269h			XXh
026Ah	CAN1 Message Box 0:Time Stamp		XXh
026Bh			XXh
026Ch			XXh
026Dh			XXh
026Eh			XXh
026Fh	CAN1 Message Box 1: Identifier / DLC		XXh
0270h			XXh
0271h			XXh
0272h			XXh
0273h			XXh
0274h	CAN1 Message Box 1: Data Field		XXh
0275h			XXh
0276h			XXh
0277h			XXh
0278h			XXh
0279h	CAN1 Message Box 1:Time Stamp		XXh
027Ah			XXh
027Bh			XXh
027Ch			XXh
027Dh			XXh
027Eh	CAN1 Message Box 1:Time Stamp		XXh
027Fh			XXh

X: Undefined

NOTE:

- Blank spaces are reserved. No access is allowed.

Table 4.13 SFR Information (13)

Address	Register	Symbol	After Reset
0300h	CAN1 Message Box 10: Identifier / DLC		XXh
0301h			XXh
0302h			XXh
0303h			XXh
0304h			XXh
0305h	CAN1 Message Box 10: Data Field		XXh
0306h			XXh
0307h			XXh
0308h			XXh
0309h			XXh
030Ah			XXh
030Bh			XXh
030Ch	CAN1 Message Box 10: Time Stamp		XXh
030Dh			XXh
030Eh	CAN1 Message Box 11: Identifier / DLC		XXh
030Fh			XXh
0310h			XXh
0311h			XXh
0312h			XXh
0313h	CAN1 Message Box 11: Data Field		XXh
0314h			XXh
0315h			XXh
0316h			XXh
0317h			XXh
0318h			XXh
0319h			XXh
031Ah	CAN1 Message Box 11: Time Stamp		XXh
031Bh			XXh
031Ch	CAN1 Message Box 12: Identifier / DLC		XXh
031Dh			XXh
031Eh			XXh
031Fh			XXh
0320h			XXh
0321h	CAN1 Message Box 12: Data Field		XXh
0322h			XXh
0323h			XXh
0324h			XXh
0325h			XXh
0326h			XXh
0327h			XXh
0328h	CAN1 Message Box 12: Time Stamp		XXh
0329h			XXh
032Ah	CAN1 Message Box 13: Identifier / DLC		XXh
032Bh			XXh
032Ch			XXh
032Dh			XXh
032Eh			XXh
032Fh	CAN1 Message Box 13: Data Field		XXh
0330h			XXh
0331h			XXh
0332h			XXh
0333h			XXh
0334h			XXh
0335h			XXh
0336h	CAN1 Message Box 13: Time Stamp		XXh
0337h			XXh
0338h	CAN1 Message Box 13: Data Field		XXh
0339h			XXh
033Ah			XXh
033Bh			XXh
033Ch			XXh
033Dh	CAN1 Message Box 13: Time Stamp		XXh
033Eh			XXh
033Fh			XXh

X: Undefined

Table 4.15 SFR Information (15) ⁽²⁾

Address	Register	Symbol	After Reset
0380h	Count Start Flag	TABSR	00h
0381h	Clock Prescaler Reset Flag	CPSRF	0XXXXXXb
0382h	One-Shot Start Flag	ONSF	00h
0383h	Trigger Select Register	TRGSR	00h
0384h	Up/Down Flag	UDF	00h ⁽¹⁾
0385h			
0386h	Timer A0 Register	TA0	XXh
0387h			XXh
0388h	Timer A1 Register	TA1	XXh
0389h			XXh
038Ah	Timer A2 Register	TA2	XXh
038Bh			XXh
038Ch	Timer A3 Register	TA3	XXh
038Dh			XXh
038Eh	Timer A4 Register	TA4	XXh
038Fh			XXh
0390h	Timer B0 Register	TB0	XXh
0391h			XXh
0392h	Timer B1 Register	TB1	XXh
0393h			XXh
0394h	Timer B2 Register	TB2	XXh
0395h			XXh
0396h	Timer A0 Mode Register	TA0MR	00h
0397h	Timer A1 Mode Register	TA1MR	00h
0398h	Timer A2 Mode Register	TA2MR	00h
0399h	Timer A3 Mode Register	TA3MR	00h
039Ah	Timer A4 Mode Register	TA4MR	00h
039Bh	Timer B0 Mode Register	TB0MR	00XX0000b
039Ch	Timer B1 Mode Register	TB1MR	00XX0000b
039Dh	Timer B2 Mode Register	TB2MR	00XX0000b
039Eh	Timer B2 Special Mode Register	TB2SC	XXXXXX00b
039Fh			
03A0h	UART0 Transmit/Receive Mode Register	U0MR	00h
03A1h	UART0 Bit Rate Register	U0BRG	XXh
03A2h	UART0 Transmit Buffer Register	U0TB	XXh
03A3h			XXh
03A4h	UART0 Transmit/Receive Control Register 0	U0C0	00001000b
03A5h	UART0 Transmit/Receive Control Register 1	U0C1	00XX0010b
03A6h	UART0 Receive Buffer Register	U0RB	XXh
03A7h			XXh
03A8h	UART1 Transmit/Receive Mode Register	U1MR	00h
03A9h	UART1 Bit Rate Register	U1BRG	XXh
03AAh	UART1 Transmit Buffer Register	U1TB	XXh
03ABh			XXh
03ACh	UART1 Transmit/Receive Control Register 0	U1C0	00001000b
03ADh	UART1 Transmit/Receive Control Register 1	U1C1	00XX0010b
03AEh	UART1 Receive Buffer Register	U1RB	XXh
03AFh			XXh
03B0h	UART Transmit/Receive Control Register 2	UCON	X0000000b
03B1h			
03B2h			
03B3h			
03B4h			
03B5h			
03B6h			
03B7h			
03B8h	DMA0 Request Source Select Register	DM0SL	00h
03B9h			
03BAh	DMA1 Request Source Select Register	DM1SL	00h
03BBh			
03BCh	CRC Data Register	CRCD	XXh
03BDh			XXh
03BEh	CRC Input Register	CRCIN	XXh
03BFh			

X: Undefined

NOTES:

1. Bits TA2P to TA4P in the UDF register are set to 0 after reset. However, the contents in these bits are undefined when read.
2. Blank spaces are reserved. No access is allowed.

Table 5.3 Recommended Operating Conditions (2) ⁽¹⁾

Symbol	Parameter				Standard			Unit
					Min.	Typ.	Max.	
f(XIN)	Main clock input oscillation frequency ^{(2) (3) (4)}	No wait	Mask ROM version Flash memory version	VCC = 3.0 to 5.5 V	0		16	MHz
f(XCIN)	Sub clock oscillation frequency					32.768	50	kHz
f(Ring)	On-chip oscillation frequency					1		MHz
f(PLL)	PLL clock oscillation frequency				16		24	MHz
f(BCLK)	CPU operation clock			VCC = 3.0 to 5.5 V	0		24	MHz
t _{su} (PLL)	PLL frequency synthesizer stabilization wait time						20	ms

NOTES:

1. Referenced to VCC = 3.0 to 5.5 V at Topr = -40 to 85°C unless otherwise specified.
2. Relationship between main clock oscillation frequency and supply voltage is shown right.
3. Execute program/erase of flash memory by VCC = 3.3 ± 0.3 V or VCC = 5.0 ± 0.5 V.
4. When using 16 MHz and over, use PLL clock. PLL clock oscillation frequency which can be used is 16 MHz, 20 MHz or 24 MHz.

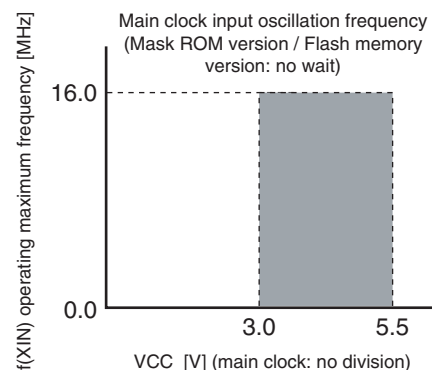


Table 5.6 A/D Conversion Characteristics ⁽¹⁾

Symbol	Parameter		Measuring Condition		Standard			Unit
					Min.	Typ.	Max.	
—	Resolution		VREF = VCC				10	Bit
INL	Integral nonlinearity error	10 bits	VREF = VCC = 5 V	ANEX0, ANEX1 input, AN0 to AN7 input, AN0_0 to AN0_7 input, AN2_0 to AN2_7 input			±3	LSB
				External operation amp connection mode			±7	LSB
			VREF = 3.3 V	ANEX0, ANEX1 input, AN0 to AN7 input, AN0_0 to AN0_7 input, AN2_0 to AN2_7 input			±5	LSB
				External operation amp connection mode			±7	LSB
		8 bits	VREF = AVCC = VCC = 3.3 V				±2	LSB
		—	Absolute accuracy	10 bits	VREF = VCC = 5 V	ANEX0, ANEX1 input, AN0 to AN7 input, AN0_0 to AN0_7 input, AN2_0 to AN2_7 input		
External operation amp connection mode						±7	LSB	
VREF = 3.3 V	ANEX0, ANEX1 input, AN0 to AN7 input, AN0_0 to AN0_7 input, AN2_0 to AN2_7 input					±5	LSB	
	External operation amp connection mode					±7	LSB	
8 bits	VREF = AVCC = VCC = 3.3 V					±2	LSB	
DNL	Differential nonlinearity error							±1
—	Offset error						±3	LSB
—	Gain error						±3	LSB
RLADDER	Resistor ladder		VREF = VCC		10		40	kΩ
tCONV	10-bit conversion time, sample & hold available		VREF = VCC = 5 V, ϕAD = 10 MHz		3.3			μs
	8-bit conversion time, sample & hold available		VREF = VCC = 5 V, ϕAD = 10 MHz		2.8			μs
tsAMP	Sampling time				0.3			μs
VREF	Reference voltage				2.0		VCC	V
VIA	Analog input voltage				0		VREF	V

NOTES:

1. Referenced to VCC = AVCC = VREF = 3.3 to 5.5 V, VSS = AVSS = 0 V, -40 to 85°C unless otherwise specified.
2. φ_{AD} frequency must be 10 MHz or less.
3. When sample & hold is disabled, φ_{AD} frequency must be 250 kHz or more in addition to a limit of NOTE 2.
When sample & hold is enabled, φ_{AD} frequency must be 1 MHz or more in addition to a limit of NOTE 2.

Table 5.7 D/A conversion Characteristics ⁽¹⁾

Symbol	Parameter	Measuring Condition	Standard			Unit
			Min.	Typ.	Max.	
—	Resolution				8	Bits
—	Absolute accuracy				1.0	%
t _{su}	Setup time				3	μs
R _O	Output resistance		4	10	20	kΩ
I _{VREF}	Reference power supply input current	(NOTE 2)			1.5	mA

NOTES:

1. Referenced to VCC = AVCC = VREF = 3.3 to 5.5 V, VSS = AVSS = 0 V, -40 to 85°C unless otherwise specified.
2. This applies when using one D/A converter, with the DAi register (i = 0, 1) for the unused D/A converter set to 00h.
The resistor ladder of the A/D converter is not included. Also, the I_{VREF} will flow even if VREF is disconnected by the ADCON1 register.

Switching Characteristics**VCC = 5 V****(Referenced to VCC = 5 V, VSS = 0 V, at Topr = –40 to 85 °C unless otherwise specified)****Table 5.25 Memory Expansion Mode and Microprocessor Mode (for setting with no wait)**

Symbol	Parameter	Measuring Condition	Standard		Unit
			Min.	Max.	
t _d (BCLK-AD)	Address output delay time	Figure 5.2		25	ns
t _h (BCLK-AD)	Address output hold time (in relation to BCLK)		4		ns
t _h (RD-AD)	Address output hold time (in relation to RD)		0		ns
t _h (WR-AD)	Address output hold time (in relation to WR)		(NOTE 1)		ns
t _d (BCLK-CS)	Chip select output delay time			25	ns
t _h (BCLK-CS)	Chip select output hold time (in relation to BCLK)		4		ns
t _d (BCLK-ALE)	ALE signal output delay time			15	ns
t _h (BCLK-ALE)	ALE signal output hold time		–4		ns
t _d (BCLK-RD)	RD signal output delay time			25	ns
t _h (BCLK-RD)	RD signal output hold time		0		ns
t _d (BCLK-WR)	WR signal output delay time			25	ns
t _h (BCLK-WR)	WR signal output hold time		0		ns
t _d (BCLK-DB)	Data output delay time (in relation to BCLK)			40	ns
t _h (BCLK-DB)	Data output hold time (in relation to BCLK) ⁽³⁾		4		ns
t _d (DB-WR)	Data output delay time (in relation to WR)		(NOTE 2)		ns
t _h (WR-DB)	Data output hold time (in relation to WR) ⁽³⁾		(NOTE 1)		ns
t _d (BCLK-HLDA)	HLDA output delay time			40	ns

NOTES:

1. Calculated according to the BCLK frequency as follows:

$$\frac{0.5 \times 10^9}{f(\text{BCLK})} - 10 \text{ [ns]}$$

2. Calculated according to the BCLK frequency as follows:

$$\frac{0.5 \times 10^9}{f(\text{BCLK})} - 40 \text{ [ns]} \quad f(\text{BCLK}) \text{ is 12.5 MHz or less.}$$

3. This standard value shows the timing when the output is off, and does not show hold time of data bus.

Hold time of data bus varies with capacitor volume and pull-up (pull-down) resistance value.

Hold time of data bus is expressed in

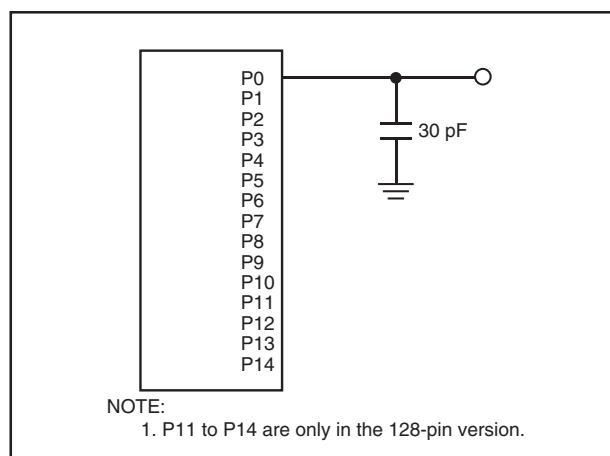
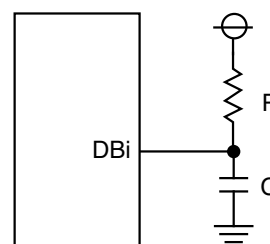
$$t = -CR \times \ln(1 - V_{OL} / V_{CC})$$

by a circuit of the right figure.

For example, when $V_{OL} = 0.2 V_{CC}$, $C = 30 \text{ pF}$,

$R = 1 \text{ k}\Omega$, hold time of output “L” level is

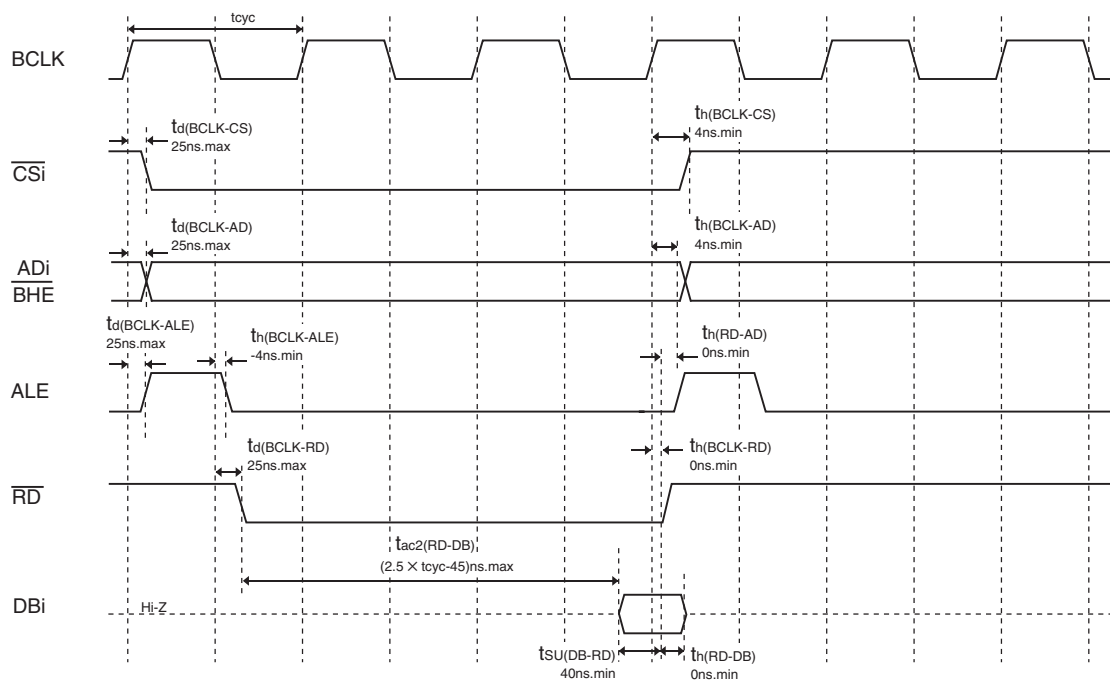
$$t = -30 \text{ pF} \times 1 \text{ k}\Omega \times \ln(1 - 0.2 V_{CC} / V_{CC}) = 6.7 \text{ ns.}$$

**Figure 5.2 Port P0 to P14 Measurement Circuit**

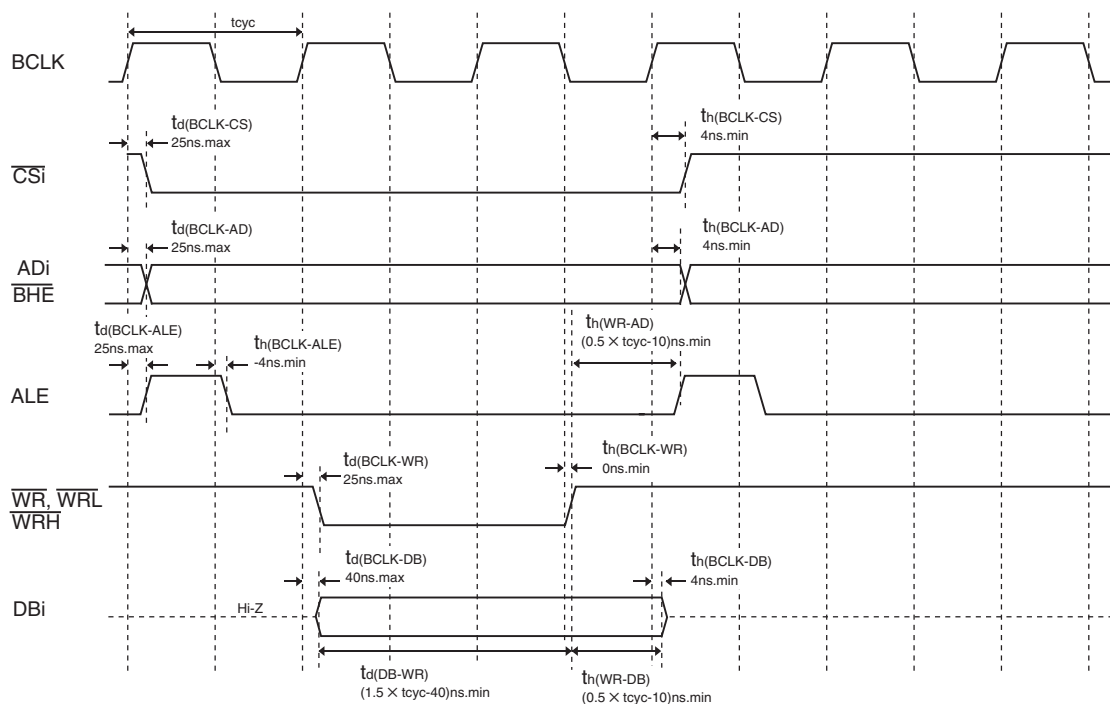
Memory Expansion Mode and Microprocessor Mode (For 2-wait setting and external area access)

VCC = 5 V

Read timing



Write timing



$$t_{cyc} = \frac{1}{f(BCLK)}$$

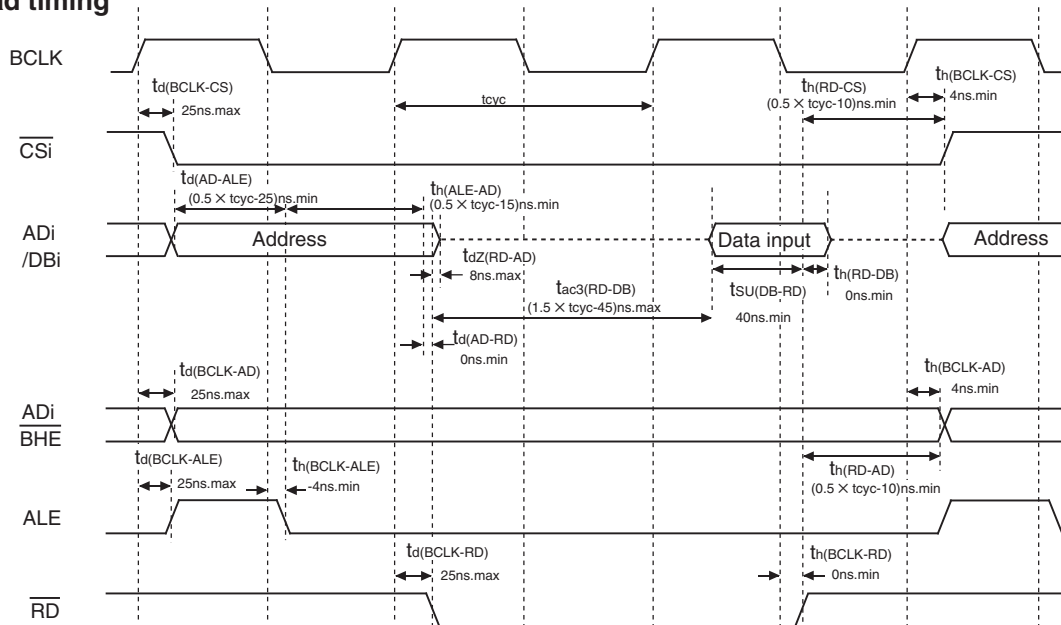
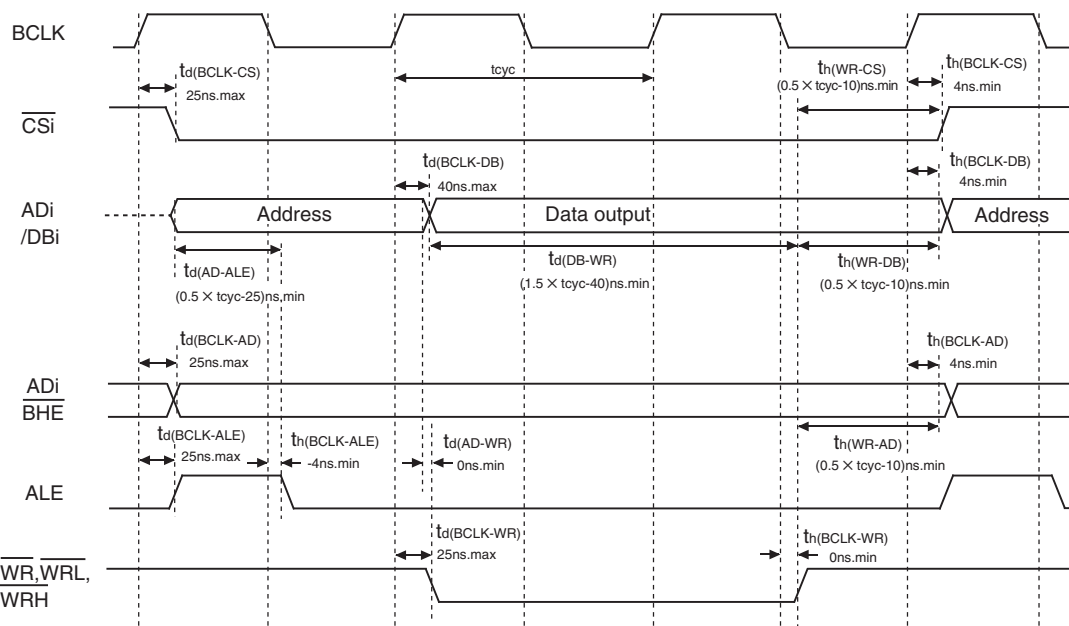
Measuring conditions :

- VCC = 5 V
- Input timing voltage : $V_{IL} = 0.8$ V, $V_{IH} = 2.0$ V
- Output timing voltage : $V_{OL} = 0.4$ V, $V_{OH} = 2.4$ V

Figure 5.7 Timing Diagram (5)

Memory Expansion Mode and Microprocessor Mode**VCC = 5 V**

(For 1- or 2-wait setting, external area access and multiplexed bus selection)

Read timing**Write timing**

$$t_{cy} = \frac{1}{f(\text{BCLK})}$$

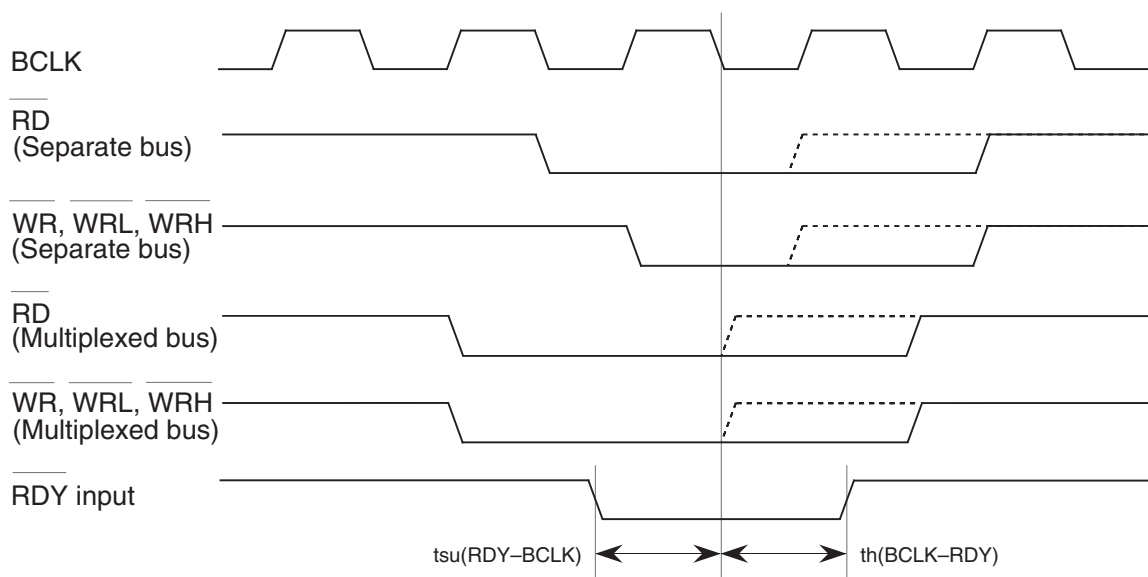
Measuring conditions :

- VCC = 5 V
- Input timing voltage : $V_{IL} = 0.8 \text{ V}$, $V_{IH} = 2.0 \text{ V}$
- Output timing voltage : $V_{OL} = 0.4 \text{ V}$, $V_{OH} = 2.4 \text{ V}$

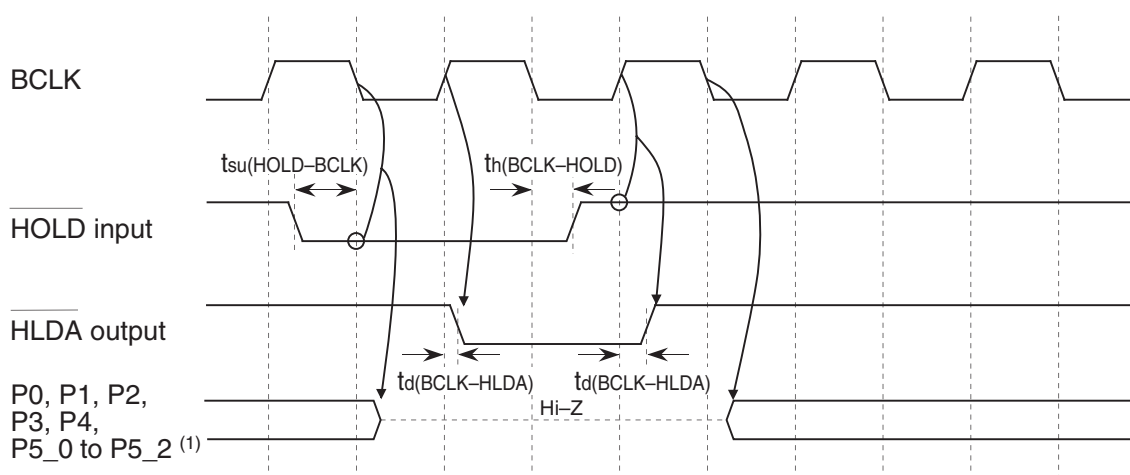
Figure 5.9 Timing Diagram (7)

Memory Expansion Mode and Microprocessor Mode**VCC = 3.3 V**

(Effective for setting with wait)



(Common to setting with wait and setting without wait)

**NOTE:**

1. The above pins are set to high-impedance regardless of the input level of the BYTE pin, the PM06 bit in the PM0 register, and the PM11 bit in the PM1 register.

Measuring conditions :

- VCC = 3.3 V
- Input timing voltage : Determined with $V_{IL} = 0.6$ V, $V_{IH} = 2.7$ V
- Output timing voltage: Determined with $V_{OL} = 1.65$ V, $V_{OH} = 1.65$ V

Figure 5.13 Timing Diagram (2)

5.2 Electrical Characteristics (T/V-ver.)

Table 5.46 Absolute Maximum Ratings

Symbol	Parameter		Condition	Rated Value	Unit
V _{CC}	Supply voltage (VCC1 = VCC2)		VCC = AVCC	−0.3 to 6.5	V
AV _{CC}	Analog supply voltage		VCC = AVCC	−0.3 to 6.5	V
V _I	Input voltage	RESET, CNVSS, BYTE, P0_0 to P0_7, P1_0 to P1_7, P2_0 to P2_7, P3_0 to P3_7, P4_0 to P4_7, P5_0 to P5_7, P6_0 to P6_7, P7_0, P7_2 to P7_7, P8_0 to P8_7, P9_0, P9_2 to P9_7, P10_0 to P10_7, P11_0 to P11_7, P12_0 to P12_7, P13_0 to P13_7, P14_0, P14_1, VREF, XIN		−0.3 to VCC+0.3	V
		P7_1, P9_1		−0.3 to 6.5	V
V _O	Output voltage	P0_0 to P0_7, P1_0 to P1_7, P2_0 to P2_7, P3_0 to P3_7, P4_0 to P4_7, P5_0 to P5_7, P6_0 to P6_7, P7_0, P7_2 to P7_7, P8_0 to P8_4, P8_6, P8_7, P9_0, P9_2 to P9_7, P10_0 to P10_7, P11_0 to P11_7, P12_0 to P12_7, P13_0 to P13_7, P14_0, P14_1, XOUT		−0.3 to VCC+0.3	V
		P7_1, P9_1		−0.3 to 6.5	V
P _d	Power dissipation		T _{opr} = 25°C	700	mW
T _{opr}	Operating ambient temperature	During MCU operation		T version: −40 to 85 V version: −40 to 125 (option)	°C
		During flash memory program and erase operation		0 to 60	
T _{stg}	Storage temperature			−65 to 150	°C

option: All options are on request basis.

NOTE:

1. Ports P11 to P14 are only in the 128-pin version.

Timing Requirements**VCC = 5 V****(Referenced to VCC = 5 V, VSS = 0 V, at Topr = –40 to 85°C unless otherwise specified)****Table 5.63 Timer B Input (Counter Input in Event Counter Mode)**

Symbol	Parameter	Standard		Unit
		Min.	Max.	
$t_{c(TB)}$	TBiIN input cycle time (counted on one edge)	100		ns
$t_{w(TBH)}$	TBiIN input HIGH pulse width (counted on one edge)	40		ns
$t_{w(TBL)}$	TBiIN input LOW pulse width (counted on one edge)	40		ns
$t_{c(TB)}$	TBiIN input cycle time (counted on both edges)	200		ns
$t_{w(TBH)}$	TBiIN input HIGH pulse width (counted on both edges)	80		ns
$t_{w(TBL)}$	TBiIN input LOW pulse width (counted on both edges)	80		ns

Table 5.64 Timer B Input (Pulse Period Measurement Mode)

Symbol	Parameter	Standard		Unit
		Min.	Max.	
$t_{c(TB)}$	TBiIN input cycle time	400		ns
$t_{w(TBH)}$	TBiIN input HIGH pulse width	200		ns
$t_{w(TBL)}$	TBiIN input LOW pulse width	200		ns

Table 5.65 Timer B Input (Pulse Width Measurement Mode)

Symbol	Parameter	Standard		Unit
		Min.	Max.	
$t_{c(TB)}$	TBiIN input cycle time	400		ns
$t_{w(TBH)}$	TBiIN input HIGH pulse width	200		ns
$t_{w(TBL)}$	TBiIN input LOW pulse width	200		ns

Table 5.66 A/D Trigger Input

Symbol	Parameter	Standard		Unit
		Min.	Max.	
$t_{c(AD)}$	ADTRG \bar input cycle time (trigger able minimum)	1000		ns
$t_{w(ADL)}$	ADTRG \bar input LOW pulse width	125		ns

Table 5.67 Serial Interface

Symbol	Parameter	Standard		Unit
		Min.	Max.	
$t_{c(CK)}$	CLKi Input cycle time	200		ns
$t_{w(CKH)}$	CLKi Input HIGH pulse width	100		ns
$t_{w(CKL)}$	CLKi Input LOW pulse width	100		ns
$t_{d(C-Q)}$	TXDi output delay time		80	ns
$t_{h(C-Q)}$	TXDi hold time	0		ns
$t_{su(D-C)}$	RXDi input setup time	70		ns
$t_{h(C-D)}$	RXDi input hold time	90		ns

Table 5.68 External Interrupt INTi Input

Symbol	Parameter	Standard		Unit
		Min.	Max.	
$t_{w(INH)}$	INTi input HIGH pulse width	250		ns
$t_{w(INL)}$	INTi input LOW pulse width	250		ns

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